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Atty. Docket No. CPAC 1029-8
Appl. No. 10/681,734

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Marcos KARNEZOS

Application No.: 10/681,734

Filed: October 8, 2003

Title: **Semiconductor multi-package module having inverted bump chip carrier second package**

Examiner: Alonzo Chambliss

Group Art Unit: 2827

Date: May 23, 2005.

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to Examiner Chambliss at the United States Patent and Trademark Office, at the Central Fax no. 703 872-9306 on May 23, 2005.

Signed _____
Bill Kennedy

MAIL STOP AMENDMENT
COMMISSIONER FOR PATENTS
P.O BOX 1450
ALEXANDRIA, VA 22313-1450

AMENDMENT

Dear Sir:

In response to the Office action mailed December 31, 2004, kindly amend the application as follows.

Amendments to the claims are reflected in the **Listing of Claims** that begins on page 2 of this paper.

Remarks begin on page 4 of this paper.

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